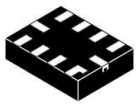
Low Voltage Dual Supply 2-Bit Signal Translator with Configurable Voltage Supplies and Signal Levels and 3-STATE Outputs and Independent Direction Controls

FXL2TD245

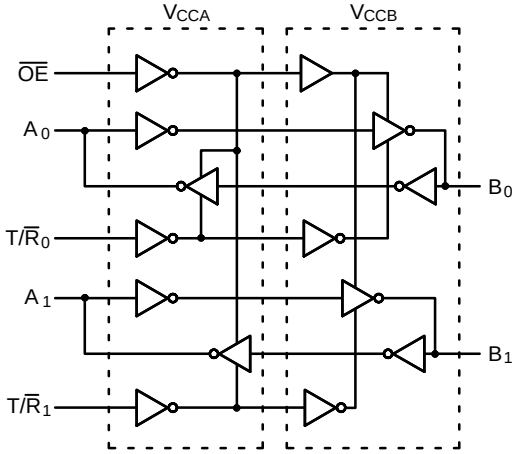


UQFN10 (MICROPAK™), 1.6 x 2.1, 0.5P
CASE 523AZ

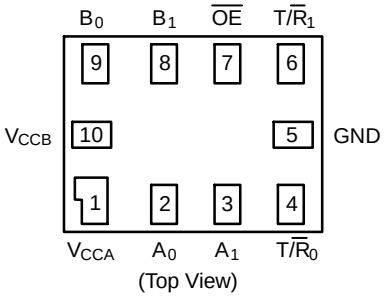
MARKING DIAGRAM

XE = Specific Device Code
&K = 2-Digits Lot Run Traceability Code
&2 = 2-Digit Date Code
&Z = Assembly Plant Code

FUNCTIONAL DIAGRAM



CONNECTION DIAGRAM



(Top View)

ORDERING INFORMATION

See detailed ordering and shipping information on page 8 of this data sheet.

General Description

The FXL2TD245 is a configurable dual-voltage-supply translator designed for both uni-directional and bi-directional voltage translation between two logic levels. The device allows translation between voltages as high as 3.6 V to as low as 1.1 V. The A Port tracks the V_{CCA} level, and the B Port tracks the V_{CCB} level. This allows for bi-directional voltage translation over a variety of voltage levels: 1.2 V, 1.5 V, 1.8 V, 2.5 V, and 3.3 V.

The device remains in 3-STATE until both V_{CC}s reach active levels allowing either V_{CC} to be powered-up first. Internal power down control circuits place the device in 3-STATE if either V_{CC} is removed.

The Transmit/Receive inputs independently determine the direction of data through each of the two bits. The $\overline{OE}$ input, when HIGH, disables both the A and B Ports by placing them in a 3-STATE condition. The FXL2TD245 is designed so that the control pins ($T/\overline{R}$ and $\overline{OE}$) are supplied by V_{CCA}.

Features

- Bi-directional Interface between Any 2 Levels from 1.1 V to 3.6 V
- Fully Configurable: Inputs Track V_{CC} Level
- Non-preferential Power-up Sequencing; Either V_{CC} May be Powered-up First
- Outputs Remain in 3-STATE until Active V_{CC} Level is Reached
- Outputs Switch to 3-STATE if Either V_{CC} is at GND
- Power-off Protection
- Control Inputs ($T/\overline{R}_n$, $\overline{OE}$) Levels are Referenced to V_{CCA} Voltage
- Packaged in the Chipscale MicroPak10 (1.6 mm x 2.1 mm)
- ESD Protections Exceeds:
  - 4kV HBM ESD (per JESD22-A114 & Mil Std 883e 3015.7)
  - 8kV HBM I/O to GND ESD (per JESD22-A114 & Mil Std 883e 3015.7)
  - 1kV CDM ESD (per ESD STM 5.3)
  - 200V MM ESD (per JESD22-A115 & ESD STM5.2)
- This Device is Pb-Free, Halide Free and is RoHS Compliant

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PIN ASSIGNMENT

Pin Number	Terminal Name
1	V_{CCA}
2	A_0
3	A_1
4	$T/\overline{R}_0$
5	GND
6	$T/\overline{R}_1$
7	$\overline{OE}$
8	B_1
9	B_0
10	V_{CCB}

PIN DESCRIPTION

Pin Names	Description
$\overline{OE}$	Output Enable Input
$T/\overline{R}_n$	Transmit/Receive Inputs
A_n	Side A Inputs or 3−STATE Outputs
B_n	Side B Inputs or 3−STATE Outputs
V_{CCA}	Side A Power Supply
V_{CCB}	Side B Power Supply

TRUTH TABLE

Inputs			Outputs
$\overline{OE}$	$T/\overline{R}_0$	$T/\overline{R}_1$	
L	L	X	B_0 Data to A_0 Output
L	H	X	A_0 Data to B_0 Output
L	X	L	B_1 Data to A_1 Output
L	X	H	A_1 Data to B_1 Output
H	X	X	3-STATE

H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care

Power-Up / Power-Down Sequencing

FXL translators offer an advantage in that either V_{CC} may be powered up first. This benefit derives from the chip design. When either V_{CC} is at 0 volts, outputs are in a HIGH-Impedance state. The control inputs ($T/\overline{R}_n$ and $\overline{OE}$) are designed to track the V_{CCA} supply. A pull-up resistor tying $\overline{OE}$ to V_{CCA} should be used to ensure that bus contention, excessive currents, or oscillations do not occur during power-up/power-down. The size of the pull-up resistor is based upon the current-sinking capability of the $\overline{OE}$ driver.

The recommended power-up sequence is the following:

1. Apply power to either V_{CC}.
2. Apply power to the $T/\overline{R}_n$ inputs (Logic HIGH for A-to-B operation; Logic LOW for B-to-A operation) and to the respective data inputs (A Port or B Port). This may occur at the same time as Step 1.
3. Apply power to the other V_{CC}.
4. Drive the $\overline{OE}$ input LOW to enable the device.

The recommended power-down sequence is the following:

1. Drive $\overline{OE}$ input HIGH to disable the device.
2. Remove power from either V_{CC}.
3. Remove power from the other V_{CC}.

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ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Rating
V_{CCA}, V_{CCB}	Supply Voltage	−0.5 V to +4.6 V
V_I	DC Input Voltage I/O Port A I/O Port B Control Inputs (T/$\overline{R}_n$, $\overline{OE}$)	 −0.5 V to +4.6 V −0.5 V to +4.6 V −0.5 V to +4.6 V
V_O	Output Voltage (Note 1) Outputs 3-STATE Outputs Active (A_n) Outputs Active (B_n)	 −0.5 V to +4.6 V −0.5 V to V_{CCA} + 0.5 V −0.5 V to V_{CCB} + 0.5 V
I_{IK}	DC Input Diode Current @ V_I < 0 V	−50 mA
I_{OK}	DC Output Diode Current @ V_O < 0 V V_O > V_{CC}	 −50 mA +50 mA
I_{OH} / I_{OL}	DC Output Source/Sink Current	−50 mA / +50 mA
I_{CC}	DC V_{CC} or Ground Current per Supply Pin	±100 mA
T_{STG}	Storage Temperature Range	−65 °C to +150 °C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
1. I_O Absolute Maximum Rating must be observed.

RECOMMENDED OPERATING CONDITIONS (Note 2)

Symbol	Parameter	Rating
V_{CCA} or V_{CCB}	Power Supply Operating	1.1 V to 3.6 V
	Input Voltage Port A Port B Control Inputs (T/$\overline{R}_n$, $\overline{OE}$)	 0.0 V to 3.6 V 0.0 V to 3.6 V 0.0 V to V_{CCA}
	Output Current in I_{OH}/I_{OL} with V_{CC} @ 3.0 V to 3.6 V 2.3 V to 2.7 V 1.65 V to 1.95 V 1.4 V to 1.65 V 1.1 V to 1.4 V	 ±24 mA ±18 mA ±6 mA ±2 mA ±0.5 mA
T_A	Free Air Operating Temperature	−40 °C to +85 °C
Δt/ΔV	Maximum Input Edge Rate $V_{CCA/B}$ = 1.1 V to 3.6 V	10 ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
2. All unused inputs and I/O pins must be held at V_{CCI} or GND.

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DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Conditions	V_{CCI} (V)	V_{CCO} (V)	Min	Max	Unit
V_{IH}	High Level Input Voltage (Note 3)	Data Inputs A_n, B_n	2.7−3.6	1.1−3.6	2.0	−	V
			2.3−2.7		1.6	−	
			1.65−2.3		0.65 x V_{CCI}	−	
			1.4−1.65		0.65 x V_{CCI}	−	
			1.1−1.4		0.9 x V_{CCI}	−	
		Control Pins $\overline{OE}$, T/$\overline{R}_n$ (Referenced to V_{CCA})	2.7−3.6	1.1−3.6	2.0	−	
			2.3−2.7		1.6	−	
			1.65−2.3		0.65 x V_{CCA}	−	
			1.4−1.65		0.65 x V_{CCA}	−	
			1.1−1.4		0.9 x V_{CCA}	−	
V_{IL}	Low Level Input Voltage (Note 3)	Data Inputs A_n, B_n	2.7−3.6	1.1−3.6	−	0.8	V
			2.3−2.7		−	0.7	
			1.65−2.3		−	0.35 x V_{CCI}	
			1.4−1.65		−	0.35 x V_{CCI}	
			1.1−1.4		−	0.1 x V_{CCI}	
		Control Pins $\overline{OE}$, T/$\overline{R}_n$ (Referenced to V_{CCA})	2.7−3.6	1.1−3.6	−	0.8	
			2.3−2.7		−	0.7	
			1.65−2.3		−	0.35 x V_{CCA}	
			1.4−1.65		−	0.35 x V_{CCA}	
			1.1−1.4		−	0.1 x V_{CCA}	
V_{OH}	High Level Output Voltage (Note 4)	I_{OH} = −100 μA	1.1−3.6	1.1−3.6	V_{CCO}−0.2	−	V
		I_{OH} = −12 mA	2.7	2.7	2.2	−	
		I_{OH} = −18 mA	3.0	3.0	2.4	−	
		I_{OH} = −24 mA	3.0	3.0	2.2	−	
		I_{OH} = −6 mA	2.3	2.3	2.0	−	
		I_{OH} = −12 mA	2.3	2.3	1.8	−	
		I_{OH} = −18 mA	2.3	2.3	1.7	−	
		I_{OH} = −6 mA	1.65	1.65	1.25	−	
		I_{OH} = −2 mA	1.4	1.4	1.05	−	
		I_{OH} = −0.5 mA	1.1	1.1	0.75 x V_{CCO}	−	
V_{OL}	Low Level Output Voltage (Note 4)	I_{OL} = 100 μA	1.1−3.6	1.1− 3.6	−	0.2	V
		I_{OL} = 12 mA	2.7	2.7	−	0.4	
		I_{OL} = 18 mA	3.0	3.0	−	0.4	
		I_{OL} = 24 mA	3.0	3.0	−	0.55	
		I_{OL} =12 mA	2.3	2.3	−	0.4	
		I_{OL} = 18 mA	2.3	2.3	−	0.6	
		I_{OL} = 6 mA	1.65	1.65	−	0.3	
		I_{OL} = 2 mA	1.4	1.4	−	0.35	
		I_{OL} = 0.5 mA	1.1	1.1	−	0.3 x V_{CCO}	
I_I	Input Leakage Current Control Pins	V_I = V_{CCA} or GND	1.1−3.6	3.6	−	±1.0	μA

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DC ELECTRICAL CHARACTERISTICS (continued)

Symbol	Parameter	Conditions	V_{CCI} (V)	V_{CCO} (V)	Min	Max	Unit
I_{OFF}	Power Off Leakage Current	A_n, V_I or V_O = 0 V to 3.6 V	0	3.6	−	±10.0	μA
		B_n, V_I or V_O = 0 V to 3.6 V	3.6	0	−	±10.0	
I_{OZ}	3−STATE Output Leakage (Note 5) $0 \le V_O \le 3.6$ V $V_I = V_{IH}$ or V_{IL}	A_n, B_n $\overline{OE} = V_{IH}$	3.6	3.6	−	±10.0	μA
		B_n, $\overline{OE}$ = Don't Care	0	3.6	−	+10.0	
		A_n, $\overline{OE}$ = Don't Care	3.6	0	−	+10.0	
$I_{CCA/B}$	Quiescent Supply Current (Note 6)	$V_I = V_{CCI}$ or GND; $I_O = 0$	1.1−3.6	1.1−3.6	−	20.0	μA
I_{CCZ}	Quiescent Supply Current (Note 6)	$V_I = V_{CCI}$ or GND; $I_O = 0$	1.1−3.6	1.1−3.6	−	20.0	μA
I_{CCA}	Quiescent Supply Current	$V_I = V_{CCA}$ or GND; $I_O = 0$	0	1.1−3.6	−	−10.0	μA
		$V_I = V_{CCA}$ or GND; $I_O = 0$	1.1−3.6	0	−	10.0	μA
I_{CCB}	Quiescent Supply Current	$V_I = V_{CCB}$ or GND; $I_O = 0$	1.1−3.6	0	−	−10.0	μA
		$V_I = V_{CCB}$ or GND; $I_O = 0$	0	1.1−3.6	−	10.0	μA
$\Delta I_{CCA/B}$	Increase in I_{CC} per Input; Other Inputs at V_{CC} or GND	V_{IH} = 3.0 V	3.6	3.6	−	500	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. V_{CCI} = the V_{CC} associated with the data input under test.
4. V_{CCO} = the V_{CC} associated with the output under test.
5. Don't care = Any valid logic level.
6. Reflects current per supply, V_{CCA} or V_{CCB}.

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AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	T_A = −40 °C to +85 °C										Unit
		V_{CCB} = 3.0 V to 3.6 V		V_{CCB} = 2.3 V to 2.7 V		V_{CCB} = 1.65 V to 1.95 V		V_{CCB} = 1.4 V to 1.6 V		V_{CCB} = 1.1 V to 1.3 V		
		Typ	Max	Typ	Max	Typ	Max	Typ	Max	Typ	Typ	
V_{CCA} = 3.0 V to 3.6 V												
t_{PLH}, t_{PHL}	Propagation Delay A to B	0.2	3.5	0.3	3.9	0.5	5.4	0.6	6.8	1.4	22.0	ns
	Propagation Delay B to A	0.2	3.5	0.2	3.8	0.3	4.0	0.5	4.3	0.8	13.0	
t_{PZH}, t_{PZL}	Output Enable $\overline{OE}$ to B	0.5	4.0	0.7	4.4	1.0	5.9	1.0	6.4	1.5	17.0	ns
	Output Enable $\overline{OE}$ to A	0.5	4.0	0.5	4.0	0.5	4.0	0.5	4.0	0.5	4.0	
t_{PHZ}, t_{PLZ}	Output Disable $\overline{OE}$ to B	0.2	3.8	0.2	4.0	0.7	4.8	1.5	6.2	2.0	17.0	ns
	Output Disable $\overline{OE}$ to A	0.2	3.7	0.2	3.7	0.2	3.7	0.2	3.7	0.2	3.7	
V_{CCA} = 2.3 V to 2.7 V												
t_{PLH}, t_{PHL}	Propagation Delay A to B	0.2	3.8	0.4	4.2	0.5	5.6	0.8	6.9	1.4	22.0	ns
	Propagation Delay B to A	0.3	3.9	0.4	4.2	0.5	4.5	0.5	4.8	1.0	7.0	
t_{PZH}, t_{PZL}	Output Enable $\overline{OE}$ to B	0.6	4.2	0.8	4.6	1.0	6.0	1.0	6.8	1.5	17.0	ns
	Output Enable $\overline{OE}$ to A	0.6	4.5	0.6	4.5	0.6	4.5	0.6	4.5	0.6	4.5	
t_{PHZ}, t_{PLZ}	Output Disable $\overline{OE}$ to B	0.2	4.1	0.2	4.3	0.7	4.8	1.5	6.7	2.0	17.0	ns
	Output Disable $\overline{OE}$ to A	0.2	4.0	0.2	4.0	0.2	4.0	0.2	4.0	0.2	4.0	
V_{CCA} = 1.65 V to 1.95 V												
t_{PLH}, t_{PHL}	Propagation Delay A to B	0.3	4.0	0.5	4.5	0.8	5.7	0.9	7.1	1.5	22.0	ns
	Propagation Delay B to A	0.5	5.4	0.5	5.6	0.8	5.7	1.0	6.0	1.2	8.0	
t_{PZH}, t_{PZL}	Output Enable $\overline{OE}$ to B	0.6	5.2	0.8	5.4	1.2	6.9	1.2	7.2	1.5	18.0	ns
	Output Enable $\overline{OE}$ to A	1.0	6.7	1.0	6.7	1.0	6.7	1.0	6.7	1.0	6.7	
t_{PHZ}, t_{PLZ}	Output Disable $\overline{OE}$ to B	0.2	5.1	0.2	5.2	0.8	5.2	1.5	7.0	2.0	17.0	ns
	Output Disable $\overline{OE}$ to A	0.5	5.0	0.5	5.0	0.5	5.0	0.5	5.0	0.5	5.0	
V_{CCA} = 1.4 V to 1.6 V												
t_{PLH}, t_{PHL}	Propagation Delay A to B	0.5	4.3	0.5	4.8	1.0	6.0	1.0	7.3	1.5	22.0	ns
	Propagation Delay B to A	0.6	6.8	0.8	6.9	0.9	7.1	1.0	7.3	1.3	9.5	
t_{PZH}, t_{PZL}	Output Enable $\overline{OE}$ to B	1.1	7.5	1.1	7.6	1.3	7.7	1.4	7.9	2.0	20.0	ns
	Output Enable $\overline{OE}$ to A	1.0	7.5	1.0	7.5	1.0	7.5	1.0	7.5	1.0	7.5	
t_{PHZ}, t_{PLZ}	Output Disable $\overline{OE}$ to B	0.4	6.1	0.4	6.2	0.9	6.2	1.5	7.5	2.0	18.0	ns
	Output Disable $\overline{OE}$ to A	1.0	6.0	1.0	6.0	1.0	6.0	1.0	6.0	1.0	6.0	
V_{CCA} = 1.1 V to 1.3 V												
t_{PLH}, t_{PHL}	Propagation Delay A to B	0.8	13.0	1.0	7.0	1.2	8.0	1.3	9.5	2.0	24.0	ns
	Propagation Delay B to A	1.4	22.0	1.4	22.0	1.5	22.0	1.5	22.0	2.0	24.0	
t_{PZH}, t_{PZL}	Output Enable $\overline{OE}$ to B	1.0	12.0	1.0	9.0	2.0	10.0	2.0	11.0	2.0	24.0	ns
	Output Enable $\overline{OE}$ to A	2.0	22.0	2.0	22.0	2.0	22.0	2.0	22.0	2.0	22.0	
t_{PHZ}, t_{PLZ}	Output Disable $\overline{OE}$ to B	1.0	15.0	0.7	7.0	1.0	8.0	2.0	10.0	2.0	20.0	ns
	Output Disable $\overline{OE}$ to A	2.0	15.0	2.0	12.0	2.0	12.0	2.0	12.0	2.0	12.0	

CAPACITANCE

Symbol	Parameter	Conditions	T_A = +25 °C	Unit
			Typical	
C_{IN}	Input Capacitance Control Pins ($\overline{OE}$, T/$\overline{R}_n$)	V_{CCA} = V_{CCB} = 3.3 V, V_I = 0 V or $V_{CCA/B}$	4.0	pF
$C_{I/O}$	Input/Output Capacitance A_n, B_n Ports	V_{CCA} = V_{CCB} = 3.3 V, V_I = 0 V or $V_{CCA/B}$	5.0	pF
C_{PD}	Power Dissipation Capacitance	V_{CCA} = V_{CCB} = 3.3 V, V_I = 0 V or V_{CC}, F = 10 MHz	20.0	pF

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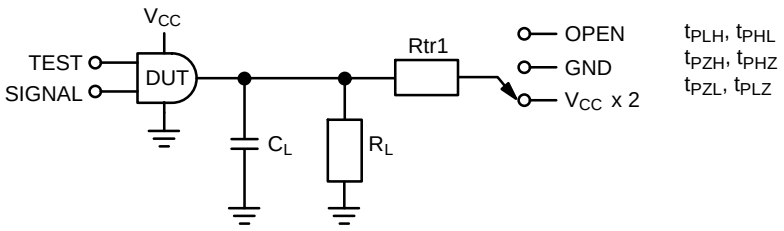
AC LOADINGS AND WAVEFORMS

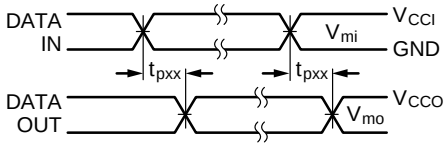


Test	Switch
t_{PLH}, t_{PHL}	OPEN
t_{PLZ}, t_{PZL}	V_{CCO} x 2 at V_{CCO} = 3.3 ±0.3 V, 2.5 V ±0.2 V, 1.8 V ±0.15 V, 1.5 V ±0.1 V, 1.2 V ±0.1 V
t_{PHZ}, t_{PZH}	GND

Figure 1. AC Test Circuit

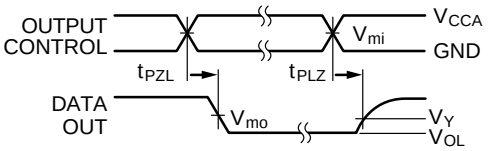
AC LOAD TABLE

V_{CCO}	C_L	R_L	Rtr1
1.2 V ±0.1 V	15 pF	2 kΩ	2 kΩ
1.5 V ±0.1 V	15 pF	2 kΩ	2 kΩ
1.8 V ±0.15 V	15 pF	2 kΩ	2 kΩ
2.5 V ±0.2 V	15 pF	2 kΩ	2 kΩ
3.3 V ±0.3 V	15 pF	2 kΩ	2 kΩ



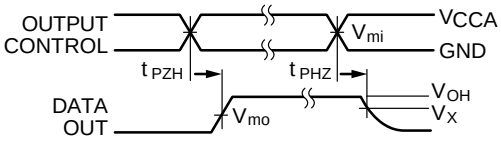
Input $t_R = t_F$ = 2.0 ns, 10% to 90%.
Input $t_R = t_F$ = 2.5 ns, 10% to 90%, @V_I = 3.0 V to 3.6 V only.

Figure 2. Waveform for Inverting and Non-Inverting Functions



Input $t_R = t_F$ = 2.0 ns, 10% to 90%.
Input $t_R = t_F$ = 2.5 ns, 10% to 90%, @ V_I = 3.0 V to 3.6 V only.

Figure 3. 3-State Output Low Enable and Disable Times for Low Voltage Logic



Input $t_R = t_F$ = 2.0 ns, 10% to 90%.
Input $t_R = t_F$ = 2.5 ns, 10% to 90%, @ V_I = 3.0 V to 3.6 V only.

Figure 4. 3-State Output High Enable and Disable Times for Low Voltage Logic

Symbol	V_{CC}				
	3.3 V ±0.3 V	2.5 V ±0.2 V	1.8 V ±0.15 V	1.5 V ±0.1 V	1.2 V ±0.1 V
V_{mi}	V_{CCI} / 2	V_{CCI} / 2	V_{CCI} / 2	V_{CCI} / 2	V_{CCI} / 2
V_{mo}	V_{CCO} / 2	V_{CCO} / 2	V_{CCO} / 2	V_{CCO} / 2	V_{CCO} / 2
V_X	V_{OH} − 0.3 V	V_{OH} − 0.15 V	V_{OH} − 0.15 V	V_{OH} − 0.1 V	V_{OH} − 0.1 V
V_Y	V_{OL} + 0.3 V	V_{OL} + 0.15 V	V_{OL} + 0.15 V	V_{OL} + 0.1 V	V_{OL} + 0.1 V

7. For V_{mi}: V_{CCI} = V_{CCA} for Control Pins T/$\overline{R}$ and $\overline{OE}$ or V_{CCA} / 2.

Share Feedback
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ORDERING INFORMATION

Order Number	Package Number	Package Description	Shipping†
FXL2TD245L10X	MAC010A	10-Lead, MicroPak, JEDEC MO255, 1.6 x 2.1 mm (Pb-Free, Halide Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MicroPak is trademark of Semiconductor Components Industries, LLC dba “onsemi” or its affiliates and/or subsidiaries in the United States and/or other countries.

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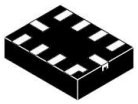
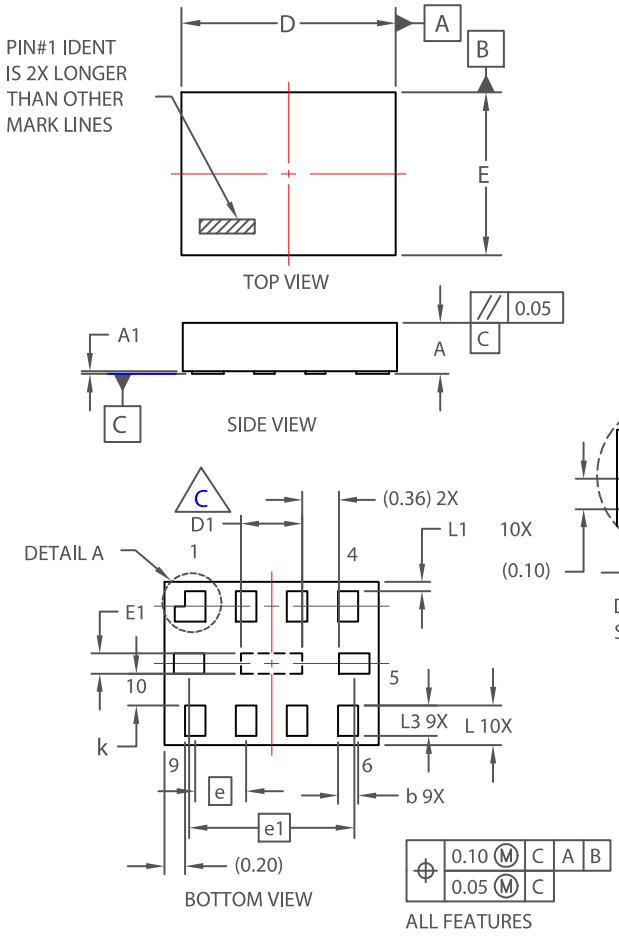


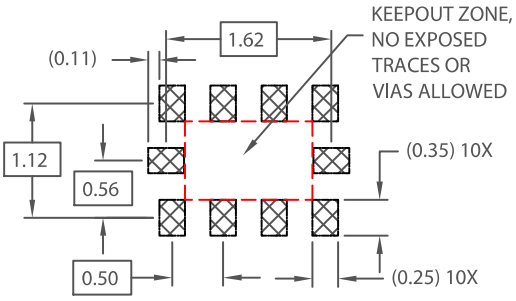
UQFN10 (MICROPAK™), 1.6X2.1, 0.5P
CASE 523AZ
ISSUE A

DATE 11 DEC 2019



NOTES:
A. PACKAGE CONFORMS TO JEDEC REGISTRATION MO-255, VARIATION UABD.
B. DIMENSIONS ARE IN MILLIMETERS.
C. PRESENCE OF CENTER PAD IS PACKAGE SUPPLIER DEPENDENT. IF PRESENT IT IS NOT INTENDED TO BE SOLDERED AND HAS A BLACK OXIDE FINISH.
D. DIMENSIONS WITHIN ( ) ARE UNCONTROLLED.

DIM	MIN.	NOM.	MAX.
A	0.50	0.55	0.65
A1	0.00	0.025	0.05
b	0.15	0.20	0.25
D	2.00	2.10	2.20
D1	0.55	0.60	0.65
E	1.50	1.60	1.70
E1	0.15	0.20	0.25
e	0.50 BSC		
e1	1.62 BSC		
k	0.20	--	--
L	0.25	0.30	0.42
L1	0.00	0.09	0.15
L3	0.25	0.30	0.35



RECOMMENDED
MOUNTING FOOTPRINT *

*FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

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